onsemi

<u>MOSFET</u> – P-Channel POWERTRENCH[®]

-40 V, 7.5 mΩ, -90 A

FDD9509L-F085

Features

- Typ $r_{DS(on)} = 6.0 \text{ m}\Omega$ at $V_{GS} = -10 \text{ V}$; $I_D = -70 \text{ A}$
- Typ $Q_{g(tot)} = 50 \text{ nC}$ at $V_{GS} = -10 \text{ V}$; $I_D = -70 \text{ A}$
- UIS Capability
- Qualified to AEC Q101
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electrical Power Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12 V Systems

ABSOLUTE MAXIMUM RATINGS (T _J = 25° C unless otherwise noted)							
Symbol	Value	Unit					
V _{DSS}	-40	V					
V _{GS}	±16	V					
۱ _D	-90	A					
۱ _D	See Figure 4	A					
E _{AS}	82	mJ					
PD	150	W					
PD	1.0	W/°C					
T _J , T _{STG}	–55 to +175	°C					
$R_{\theta JC}$	1.0	°C/W					
$R_{\theta JA}$	52	°C/W					
	Symbol V _{DSS} V _{GS} I _D I _D E _{AS} P _D P _D T _J , T _{STG} R _{θJC}	$\begin{array}{ c c c } \hline Symbol & Value \\ \hline V_{DSS} & -40 \\ \hline V_{GS} & \pm 16 \\ \hline I_D & -90 \\ \hline I_D & See \\ \hline Figure 4 \\ \hline E_{AS} & 82 \\ \hline P_D & 150 \\ \hline P_D & 1.0 \\ \hline T_J, T_{STG} & -55 to \\ +175 \\ \hline R_{\theta JC} & 1.0 \\ \hline \end{array}$					

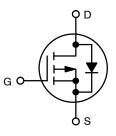
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Current is limited by wirebond configuration

- 2. Starting Tj = 25°C, L = 40 μ H, I_{AS} = –64 A, V_{DD} = –40 V during inductor charging and V_{DD} = 0 V during time in avalanche
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.



TO-252 CASE 369AS



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	Quantity
FDD9509L-F085	FDD9509L	D-PAK (TO-252)	13″		

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
FF CHARAC	TERISTICS						-
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I _D =	–250 μA	-40	-	-	V
I _{DSS}	Drain to Source Leakage Current	$V_{aa} = 0 V$	$T_J = 25^{\circ}C$	-	-	-1	μA
			T _J = 175°C (Note 4)	-	-	-1	mA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±16 V	•	-	-	±100	nA
N CHARACT	ERISTICS						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		-1	-2	-3	V
R _{DS(on)}	Drain to Source On-Resistance	V_{GS} = -4.5 V, I_D = -35 A, T_J = 25 $^\circ C$		-	8.7	15	mΩ
	V _{GS}	$V_{GS} = -10 V,$	$V_{GS} = -10 \text{ V}, T_J = 25^{\circ}\text{C}$	-	6.0	7.5	mΩ
		I _D = -70 A	T _J = 175°C (Note 4)	-	10	12.6	mΩ
YNAMIC CH	ARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		-	3350	-	pF
C _{oss}	Output Capacitance			-	1250	-	pF
C _{rss}	Reverse Transfer Capacitance			-	42	-	pF
Rg	Gate Resistance	$V_{GS} = -0.5 \text{ V}, \text{ f} = 1 \text{ MHz}$		-	22	-	Ω
Q _{g(tot)}	Total Gate Charge	$V_{DD} = -20 \text{ V},$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{D} = -70 \text{ A}$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$		-	50	75	nC
0	Total Gate Charge				23		nC

C _{iss}	Input Capacitance	V_{DS} = -20 V, V_{GS} = 0 V, f = 1 MHz		-	3350	-	pF	
C _{oss}	Output Capacitance	Ι Γ		_	1250	-	pF	
C _{rss}	Reverse Transfer Capacitance			_	42	-	pF	
Rg	Gate Resistance	$V_{GS} = -0.5 \text{ V}, \text{ f} = 1 \text{ MHz}$		_	22	-	Ω	
Q _{g(tot)}	Total Gate Charge	V _{DD} = -20 V, I _D = -70 A	V_{GS} = 0 V to –10 V	_	50	75	nC	
Q _{g(-4.5)}	Total Gate Charge	ID = -70 K	10 = -70 A	V_{GS} = 0 V to -4.5 V	_	23	-	nC
Q _{g(th)}	Threshold Gate Charge		V_{GS} = 0 V to -1 V	_	3.5	-	nC	
Q _{gs}	Gate to Source Gate Charge	$V_{DD} = -20 \text{ V}, \text{ I}_{D} = -70 \text{ A}$		_	12	_	nC	
Q _{gd}	Gate to Drain "Miller" Charge			-	6	-	nC	

SWITCHING CHARACTERISTICS

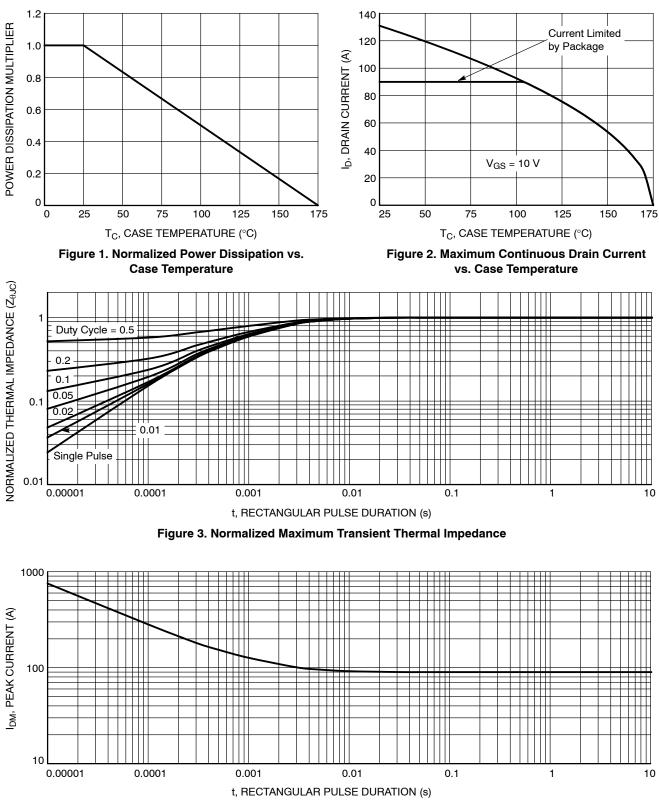
t _{on}	Turn-On Time		-	-	16	ns
t _{d(on)}	Turn-On Delay Time		-	8.0	-	ns
t _r	Turn-On Rise Time		-	4.0	-	ns
t _{d(off)}	Turn-Off Delay Time	-	-	190	-	ns
t _f	Turn-Off Fall Time		-	60	-	ns
t _{off}	Turn-Off Time		-	-	375	ns

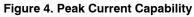
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Source to Drain Diode Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = -70 \text{ A}$	-	-0.96	-1.25	V
		V_{GS} = 0 V, I_{SD} = -35 A	-	-0.88	-1.2	V
T _{rr}	Reverse Recovery Time	$I_F = -70 \text{ A}, \text{ dI}_{SD}/\text{dt} = 100 \text{ A}/\mu\text{s}$	-	54	71	ns
Q _{rr}	Reverse Recovery Charge		-	43	57	nC

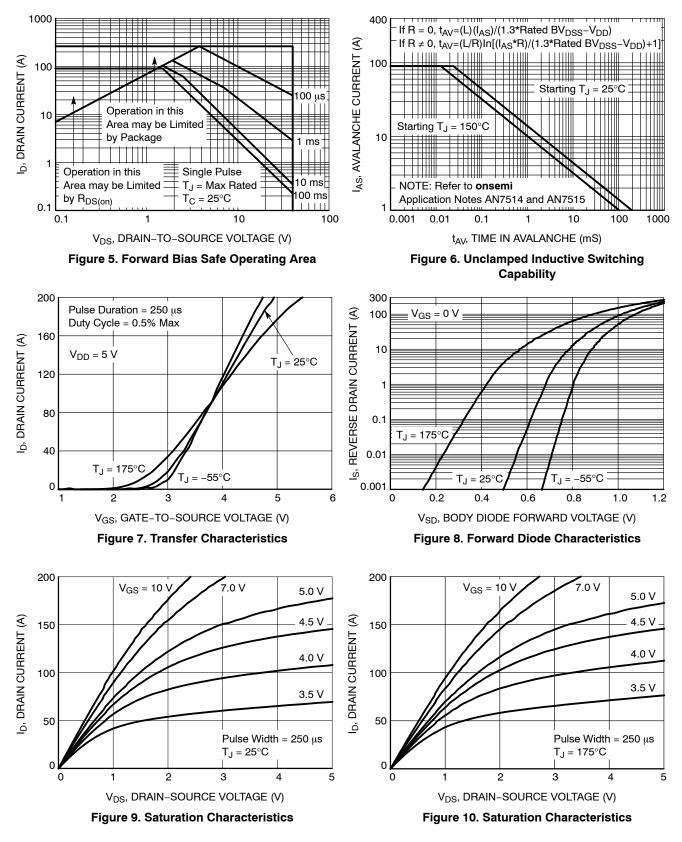
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production

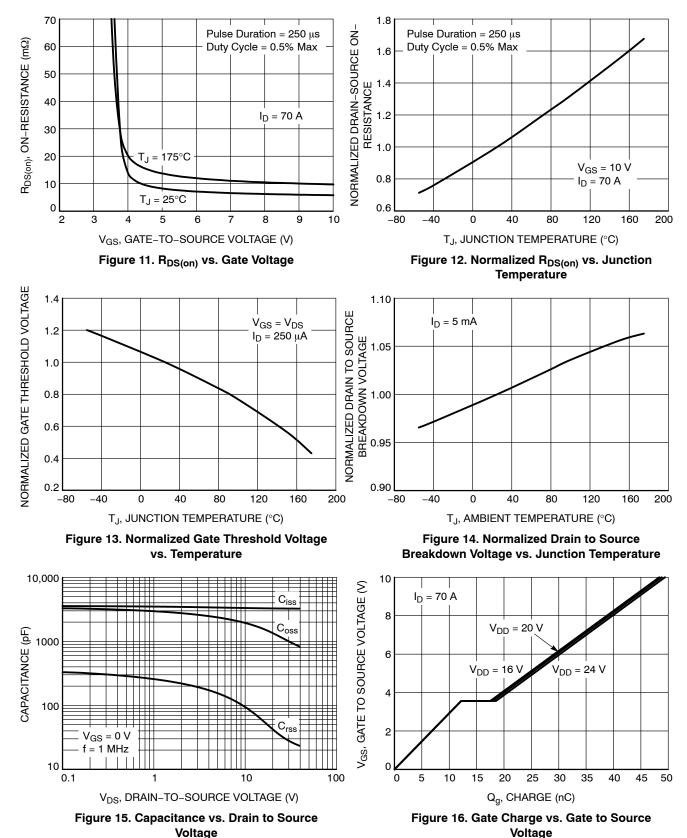
TYPICAL CHARACTERISTICS







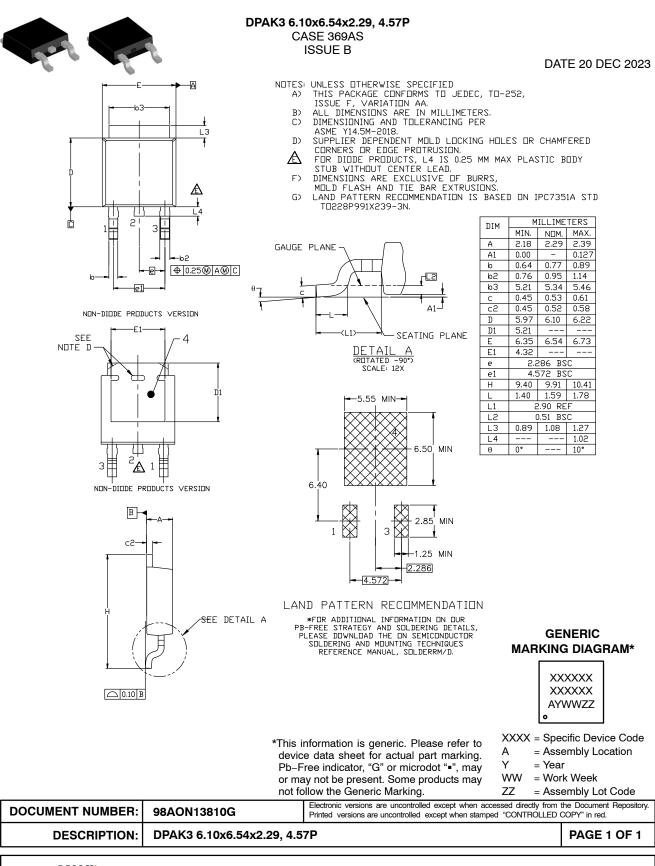




TYPICAL CHARACTERISTICS

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